## 506135447 07/01/2020

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6182174

 SUBMISSION TYPE:
 NEW ASSIGNMENT

 NATURE OF CONVEYANCE:
 ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
DIDI RESEARCH AMERICA, LLC	04/29/2020

#### **RECEIVING PARTY DATA**

Name:	DIDI (HK) SCIENCE AND TECHNOLOGY LIMITED
Street Address:	2/F, HONG KONG OFFSHORE CENTRE, 28 AUSTIN AVENUE
City:	TSIM SHA TSUI, KOWLOON
State/Country:	HONG KONG

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	16237096

#### **CORRESPONDENCE DATA**

**Fax Number:** (202)408-4400

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

**Phone:** 202-408-4000

**Email:** regional-desk@finnegan.com

Correspondent Name: FINNEGAN, HENDERSON, FARABOW, GARRETT &

Address Line 1: 901 NEW YORK AVENUE, NW
Address Line 4: WASHINGTON, D.C. 20001-4413

ATTORNEY DOCKET NUMBER:	14198.0092-00000	
NAME OF SUBMITTER:	DONNA O. BECKFORD	
SIGNATURE:	/Donna O. Beckford/	
DATE SIGNED:	07/01/2020	

## **Total Attachments: 2**

source=s1\_Finnegan#page1.tif source=s1\_Finnegan#page2.tif

PATENT 506135447 REEL: 053104 FRAME: 0545

SOLE/JOINT INVENTION (Worldwide Rights) Attorney Docket No. 14198.0091 & 0092

#### ASSIGNMENT

WHEREAS, DIDI RESEARCH AMERICA, LLC, a California legal entity whose post office address is 450 National Avenue, Mountain View, California 94043 (hereinafter referred to as Assignor), is the owner of inventions as disclosed and claimed in the following patent applications:

Application Number	Country of Filing	Filing Date
International Application No. PCT/US18/68182	U.S. as the receiving office	December 31, 2018
U.S. Application No. 16/236,959	U.S.	December 31, 2018
International Application No. PCT/US18/68199	U.S. as the receiving office	December 31, 2018
U.S. Application No. 16/237,096	U.S.	December 31, 2018

WHEREAS, DIDI (HK) Science and Technology Limited, a corporation of Hong Kong whose post office address is 2/F, Hong Kong Offshore Centre, 28 Austin Avenue, Tsim Sha Tsui, Kowloon, Hong Kong (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to the inventions in all countries throughout the world, and in and to all applications for patents on the inventions in all countries throughout the world, including any PCT International Applications and all national stage applications based thereon that may be filed, and all patents issued upon such applications in all countries throughout the world;

NOW THEREFORE, be it known that, for good and valuable consideration the receipt of which from Assignee is hereby acknowledged, Assignor, has sold, assigned, transferred, and set over, and does hereby sell, assign, transfer, and set over unto Assignee, its lawful successors and assigns, Assignor's entire right, title, and interest in and to the inventions, the above-referenced applications that disclose and claim the inventions, any PCT International Applications and all national stage applications based thereon that may be filed, any other applications for patents filed anywhere in the world that claim the inventions, and all divisions, and continuations of any such applications, and all patents which may be granted thereon, and all reissues thereof, and all rights to claim priority in any country on the basis of any such applications, and all extensions, renewals, and reissues thereof; and Assignor hereby authorizes and requests any official of any country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for the inventions to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, Assignor covenants that Assignor has the full right to convey the interest assigned by this Assignment, and Assignor has not executed and will not execute any agreement in conflict with this Assignment;

AND, Assignor further covenants and agrees that Assignor will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to Assignor respecting the inventions, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to each of the inventions in Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for the inventions in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by Assignee, its successors and assigns.

Page 1 of 2

SOLE/JOINT INVENTION (Worldwide Rights) Attorney Docket No. 14198.0091 & 0092

Assignor Name:	DIDI RESEARCH AMERICA, LLC	
	DocuSigned by:	
Signature:	Fenguin Gong	
Printed Name:	Fengmin Gong	
Corporate Title:	Vice President	
Date:	April 29, 2020	
Assignee Name:	DIDI (HK) Science and Technology Limited	
Signature:	一个	
Printed Name:	CHENG Wei	
Corporate Title:	Director	
Date:	April 29, 2020	

**RECORDED: 07/01/2020**